Ingar Fredriksen AVR Applications Manager

Tromsø August 12, 2005



The history of computers



Foundation for modern computing



- An automatic computing machine must have:
 - A store for the numbers (memory)
 - A device for performing arithmetic operations (ALU)
 - A device for causing the operations of the machine (CU)
 - An input and output device (Mouse, keyboard, screen)

First Generation: The Manchester Computer

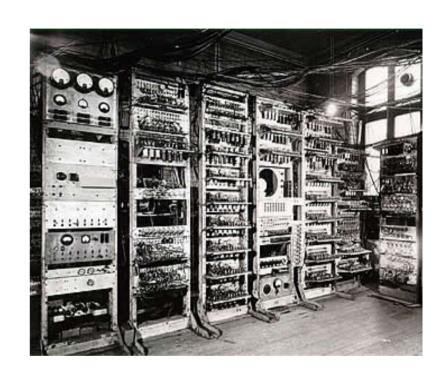


 The world's first storedprogram electronic digital computer

 Executed its first program on June 21st in 1948.

 Designed and constructed by Machester University

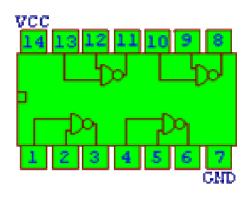
 Ferranti Ltd. was given rights to produce and sell a commercial version of the machine (Manchester mark I)



The Most Important Step: Integrated Circuits



 The introduction of integrated circuits led to the third generation of computers



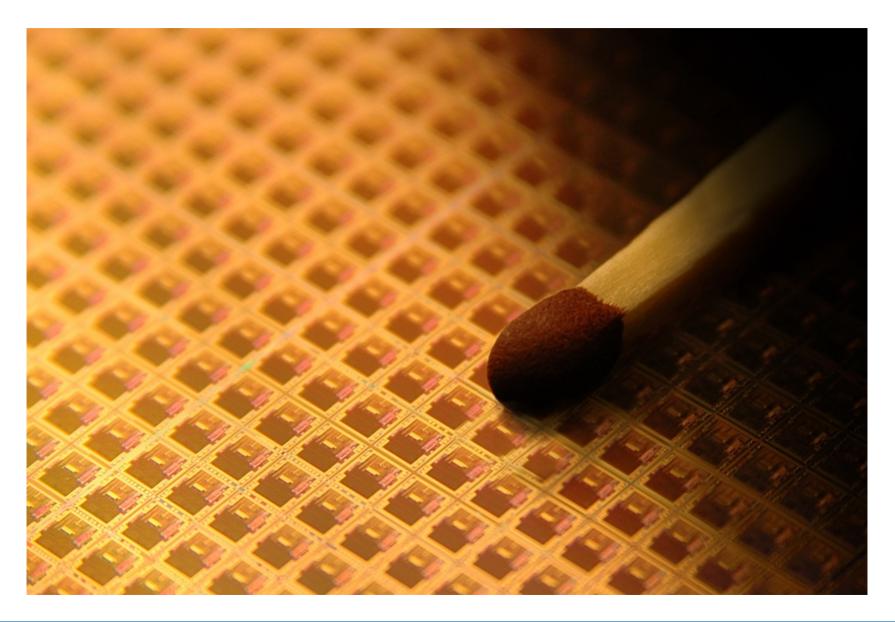
 Mini-machines made out of logic gates

Small scale integrated circuits













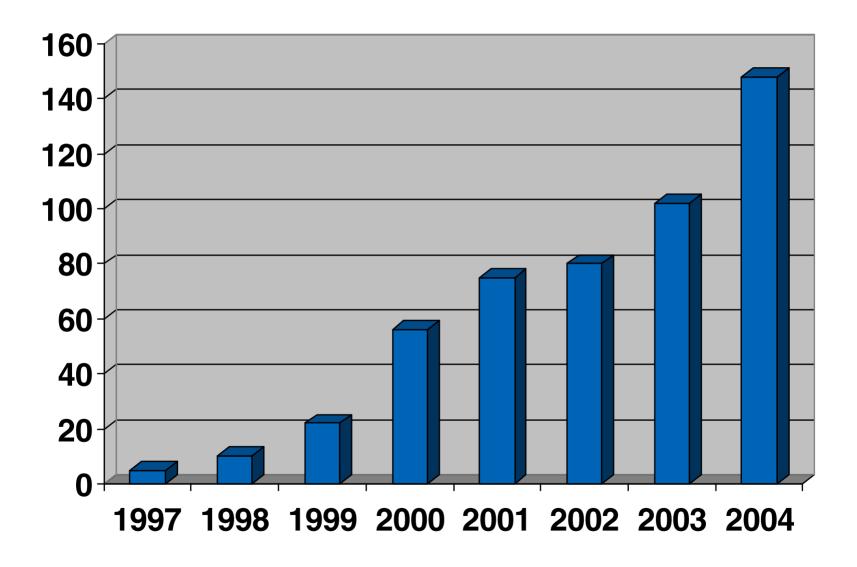
The AVR fairy tale how the west was won and how we got there





AVR Standard Product Revenues





Atmel Norway AS - today



- 120 employees in Trondheim
- 50 employees abroad
- 35 products in production
- 12.000.000 chips/month
- 4.5 chips pr. second
- Own 100% by Atmel Corp
 - Nasdag: ATML



Key AVR Features – the sales pitch



- Flash and EEPROM, both in-system programmable
- Highest performance, low power 8-bit MCU
- Excellent code density in C and assembly
- A broad family of MCUs 1K to 256K Bytes flash
- High integration







256K	[Flash Size]							Mega2561	Mega2560
								Mega1281 USB128	Mega1280
128K								CAN128 Mega128	Mega 1200
64K						Mega644		Mega649 Mega645 CAN64 USB64	Mega6490 Mega6450 Mega640
	Production							Mega64	
40K	Future						Mega406		
								CAN32	Mega3290
32K						Mega32		Mega329 Mega325	Mega3250
16K					Mega168	Mega16		Mega169	
1010					Mogaroo	Mega162		Mega165	
					PWM3	Mega8535			
8K	Tiny85	Tiny84	Tiny86	PWM2	Mega88 Mega8	Mega8515			
4K	Tiny45	Tiny44	Tiny46	PWM1	Mega48				
2K	Tiny25	Tiny24	Tiny26 T2313		Tiny28				
1K	Tiny15 Tiny13 Tiny11								
	8-pin	14-pin	20-pin	24-pin	32-pin	44-pin	48-pin	64-pin	100-pin

13

8-Pin Family Details



• Tiny25/45/85

- Three Pin and fuctionally compatible devices
- 4-channel 10-bit ADC
 - Differential channels with 10/20X Gain
- High frequency (200 KHz) 8-bit PWM
- Pin-change interrupt on all I/O-pins
- Low power consumption
 - 100 nA power down mode
- debugWIRE On-chip Debug

Tiny13

- Pin compatible with Tiny25/45/85
- 4-channel 10-bit A/D
- Pin-change interrupt on all I/O pins
- Low power consumption
- 100 nA power down mode
- debugWIRE On-chip Debug

Device	Flash	RAM	EEprom	
Tiny13	1K	64	64	
Tiny25	2K	128	128	
Tiny45	4K	256	256	
Tiny85	8K	512	512	



14-pin family highlights



- Pin/Functionally compatible devices
- 8-channel 10-bit ADC
 - 7 Differential channels with 1/8/20X Gain
- Pin-change interrupt on all I/O-pins
- Low power consumption
 - 100 nA power down mode
 - 1.8 to 5.5 volt operation
- Internal 8 MHz RC oscillator
- debugWIRE On-chip Debug

Device	Flash	RAM	EEprom
Tiny24	2K	128	128
Tiny44	4K	256	256
Tiny84	8K	512	512



20-pin family



- Tiny26/46/86
 - 11-channel 10-bit A/D
 - Differential Channels with 10/20X gain
 - High frequency (200 KHz) PWM
 - Debugwire On-Chip Debug (Tiny45/85)
 - 8 MHz Internal RC
- Tiny2313
 - Hardware USART
 - Interrupt on pin-change on all I/O
 - USI gives hardware support for SPI/TWI
 - Low power consumption
 - 100 nA Power down mode
 - DebugWIRE On-Chip Debug

Device	Flash	RAM	EE	VCC
Tiny26	2K	128	128	2.7 – 5.5V
Tiny46	4K	256	256	1.8 – 5.5V
Tiny86	8K	512	512	1.8 – 5.5V
Tiny2313	2K	128	128	1.8 – 5.5V

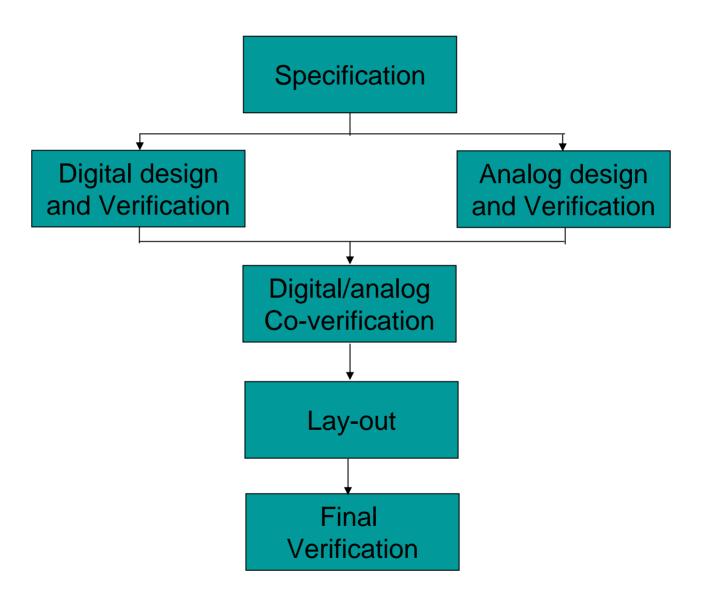


The Development of an AVR Microcontroller



Developing a Microcontroller





Digital Design



 CPU, Interrupt Controller, DMA, Peripheral Functions etc.

- Developed in HDL (Verilog)
- Verification on HDL model
- Module Reuse and Improvement
- IP Modules
- HDL synthesis

Verilog Example:

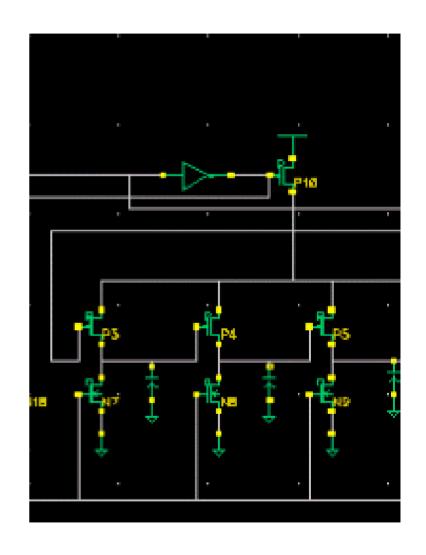
```
always @ (posedge clk)
begin // Register write
 if((adr==UCSRB_adr)&iowe)
   begin
    rxcie <= `DD dbus[7]:
    txcie <= `DD dbus[6];
    udrie <= `DD dbus[5];
    rxen <= `DD dbus[4];
    txen <= `DD dbus[3];
    chr9 <= `DD dbus[2];
   end
end
```

Analog Design



 Memories, ADCs, DACs, Regulators, Oscillators, PADs, etc.

- Analog modules implemented as schematic drawings
- Digital Interfaces
- IP Modules
- Process shrink (libraries)
 0.35μ, 0.25μ, 0.18μ, 0.13μ



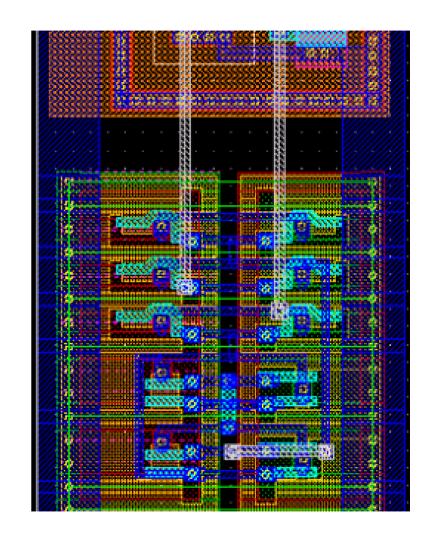
Lay Out



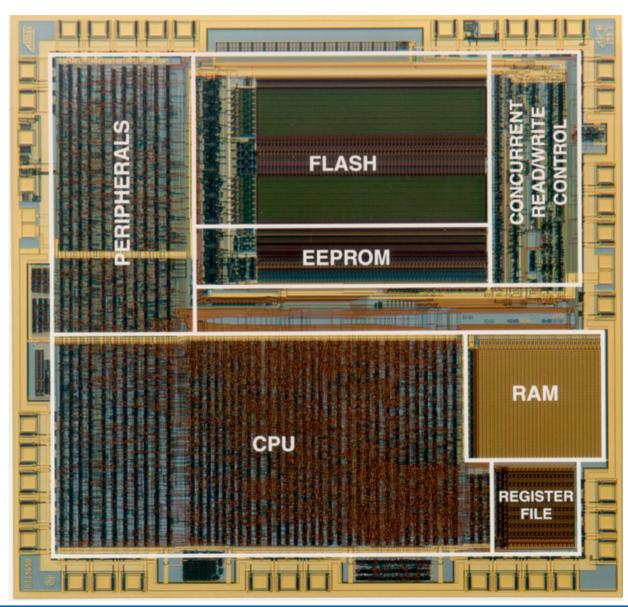
 The Digital Design has been synthesized to a low level representation

 The Digital Design has to be merged with the Analog Design

 The Lay Out must meet performance and size constraints







Packaging

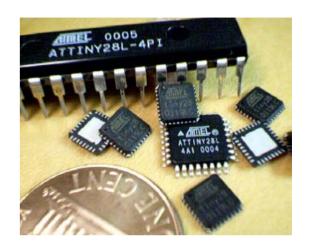


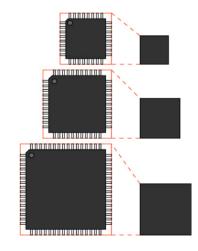
- Die
 - All devices available in Die Form
- Micro Lead Frame Packaging
 - Low cost package technology
 - Very good noise immunity substrate connected to ground
 - Smallest standard package available
 - Near chip-scale package size; Save up to 69% of board space

TQFP size	MLF size TQFP area		MLF area	
9 x 9	5 x 5	81	25	31 %
12 x 12	7 x 7	144	49	34 %
16 x 16	9 x 9	256	81	32 %

Size in millimeters

Area in mm²





The future



Trends into the future



- Shrink
 - Size decrease will continue
 - Lower production cost and end user price
- Lower power
 - Today 1.8V operation
 - 1 Li cell or 2 AA/AAA batteries to run
 - 0.9V technology will be introduced
 - 1 AA/AAA battery to run
- On-chip debug
 - The end of expensive in-circuit emulators
- Open source
 - Linux OS
 - User interaction. www.avrfreaks.net